



# Spread Spectrum Clock Generator

MB88155 is a clock generator for EMI (Electro Magnetic Interference) reduction. The peak of unnecessary radiation noise (EMI) can be attenuated by making the oscillation frequency slightly modulate periodically with the internal modulator. For modulation, the MB88155 supports both center-spreading and down-spreading. It has a non-modulated clock output pin (REFOUT) as well as a modulated clock output pin (CKOUT).

#### **Features**

■ Input frequency: 12.5 MHz to 50 MHz (Multiplied by 1)

12.5 MHz to 20 MHz (Multiplied by 4)

■ Output frequency : CKOUT 12.5 MHz to 80 MHz

REFOUT The same as input frequency (not multiplied)

 $\blacksquare$  Modulation rate :  $\pm$  0.5%,  $\,\pm$  1.0% (center spread) , - 1.0%, - 2.0% (Down spread)

■ Equipped with oscillation circuit : range of oscillation 12.5 MHz to 40 MHz (Fundamental oscillation)

40 MHz to 48 MHz (3rd overtone)

■ Modulation clock output Duty: 40% to 60%

■ Modulation clock cycle — cycle jitter: MB88155-1xx 12.5 MHz to 20 MHz less than 150 ps

MB88155-1xx 20 MHz to 50 MHz less than 100 ps MB88155-400 less than 200 ps

■ Low current consumption by CMOS process : 5 mA (24 MHz : Typ-sample, no load)

■ Power supply voltage : 3.3 V ± 0.3 V

■ Operating temperature : -40 °C to +85 °C

■ Package: 8-pin plastic TSSOP



## **Contents**

| Product Lineup                                | 3    |
|---|------|
| Pin Assignment                                | 3    |
| Pin Description                               | 4    |
| I/O Circuit Type                              | 5    |
| Handling Devices                              | 7    |
| Preventing Latch-up                           |      |
| Handling Unused Pins                          | 7    |
| The Attention when the External Clock is Used |      |
| Power Supply Pins                             | 7    |
| Oscillation Circuit                           | 7    |
| Block Diagram                                 | 8    |
| Pin Setting                                   | 9    |
| Absolute Maximum Ratings                      | . 11 |
| Recommended Operating Conditions              | . 12 |
| Electrical Characteristics                    | . 13 |

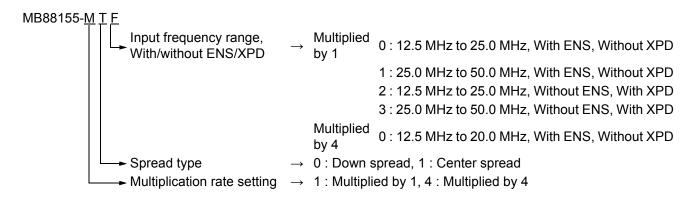
| Output Clock Duty Cycle (tDCC, tDCR = tb/ta) | 15 |
|--|----|
| Input Frequency (fin = 1/tin)                | 15 |
| Output Slew Rate (SRC, SRR)                  | 15 |
| Cycle-Cycle Jitter (tJC =  tn - tn + 1  )    | 16 |
| Modulation Waveform                          | 17 |
| Lock-Up Time                                 | 18 |
| Oscillation Circuit                          | 20 |
| Interconnection Circuit Example              | 21 |
| Spectrum Example Characteristics             | 22 |
| Ordering Information                         | 23 |
| Package Dimensions                           |    |
| Document History                             | 26 |
| Sales, Solutions, and Legal Information      | 27 |



### 1. Product Lineup

The MB88155 is available in different models: 2 models different in multiplier ( $\times$  1 and  $\times$  4), 2 in modulation type (center-spreading and down-spreading), 2 in input frequency range at a multiplier of 1 (12.5 MHz to 25 MHz and 25 MHz to 50 MHz), and 1 in input frequency range at a multiplier of 4 (12.5 MHz to 20 MHz).

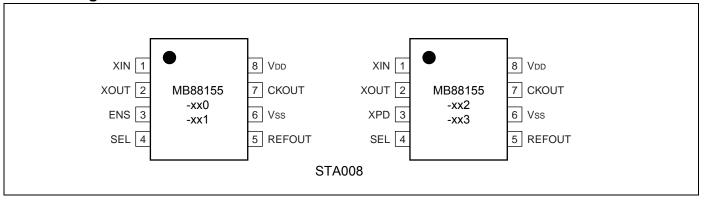
The MB88155 is also available in two versions: modulation-on/off selectable version (with ENS pin) and power-down function built-in version (with XPD pin).



### Line-up of MB88155

| Product     | Input Frequency    | Multiplication<br>Rate | Output<br>Frequency | Modulation<br>Type          | Modulation<br>Enable pin | Power<br>Down Pin |                 |  |     |
|-------------|--------------------|------------------------|---------------------|-----------------------------|--------------------------|-------------------|-----------------|--|-----|
| MB88155-100 | 12.5 MHz to 25 MHz |                        |                     | Down                        | Yes                      | No                |                 |  |     |
| MB88155-102 | 12.5 MHz to 25 MHz | Multiplied by 1        |                     | spread                      | No                       | Yes               |                 |  |     |
| MB88155-103 | 25 MHz to 50 MHz   |                        | Multiplied by 1     | The same as input frequency |                          |                   |                 |  |     |
| MB88155-110 | 12.5 MHz to 25 MHz |                        |                     | Multiplied by 1             | waitiplied by 1          | Maniphed by 1     | multiplied by 1 |  | Yes |
| MB88155-111 | 25 MHz to 50 MHz   |                        |                     | Center<br>spread            |                          |                   |                 |  |     |
| MB88155-112 | 12.5 MHz to 25 MHz |                        |                     | '                           | No                       | Yes               |                 |  |     |
| MB88155-400 | 12.5 MHz to 20 MHz | Multiplied by 4        | 50 MHz to<br>80 MHz | Down<br>spread              | Yes                      | No                |                 |  |     |

### 2. Pin Assignment



Document Number: 002-08298 Rev. \*B Page 3 of 27



## 3. Pin Description

| Pin Name        | 1/0 | Pin No. | Description   |  |
|-----------------|-----|---------|---|--|
| XIN             | I   | 1       | Connection pin of resonator/clock input pin   |  |
| XOUT            | 0   | 2       | Connection pin of resonator   |  |
| ENS/XPD         | I   | 3       | Modulation enable pin/power down pin  |  |
| SEL             | l   | 4       | Modulation rate setting pin Down spread, SEL = "L" : Modulation rate $-1.0\%$ Down spread, SEL = "H" : Modulation rate $-2.0\%$ Down spread, SEL = "L" : Modulation rate $\pm 0.5\%$ Down spread, SEL = "H" : Modulation rate $\pm 1.0\%$ |  |
| REFOUT          | 0   | 5       | Non-modulated clock output pin This pin becomes to "L" at power-down.   |  |
| Vss             | _   | 6       | GND Pin   |  |
| CKOUT           | 0   | 7       | Modulated clock output pin This pin becomes to "L" at power-down.   |  |
| V <sub>DD</sub> | _   | 8       | Power supply voltage pin  |  |

Document Number: 002-08298 Rev. \*B Page 4 of 27



## 4. I/O Circuit Type

| Pin         | Circuit Type                               | Remarks   |
|-------------|--|---|
| SEL,<br>XPD |  | CMOS hysteresis input   |
| ENS         | 50 kΩ    S   S   S   S   S   S   S   S   S | CMOS hysteresis input with pull-up resistor of 50 k $\Omega$ (Typ)                          |
| REFOUT      |  | <ul> <li>■ CMOS output</li> <li>■ IoL = 3 mA</li> <li>■ "L" output at power-down</li> </ul> |

(Continued)



### (Continued)

| Pin   | Circuit Type | Remarks                    |
|-------|--------------|----------------------------|
|       |              | ■ CMOS output              |
|       | <del>-</del> | ■ IoL = 4 mA               |
|       |              | ■ "L" output at power-down |
| СКОПТ |              |                            |

Note: For XIN pin and XOUT pin, refer to "Oscillation Circuit".



### 5. Handling Devices

#### 5.1 Preventing Latch-up

A latch-up can occur if, on this device, (a) a voltage higher than  $V_{DD}$  or a voltage lower than  $V_{SS}$  is applied to an input or output pin or (b) a voltage higher than the rating is applied between  $V_{DD}$  and  $V_{SS}$ . The latch-up, if it occurs, significantly increases the power supply current and may cause thermal destruction of an element. When you use this device, be very careful not to exceed the maximum rating.

#### 5.2 Handling Unused Pins

Do not leave an unused input pin open, since it may cause a malfunction. Handle by, using a pull-up or pull-down resistor. Unused output pin should be opened.

#### 5.3 The Attention when the External Clock is Used

Input the clock to XIN pin, and XOUT pin should be opened when you use the external clock. Please pay attention so that an overshoot and an undershoot do not occur to an input clock of XIN pin.

#### 5.4 Power Supply Pins

Please design connecting the power supply pin of this device by as low impedance as possible from the current supply source.

We recommend connecting electrolytic capacitor (about 10  $\mu$ F) and the ceramic capacitor (about 0.01  $\mu$ F) in parallel between Vss and V<sub>DD</sub> near the device, as a bypass capacitor.

#### 5.5 Oscillation Circuit

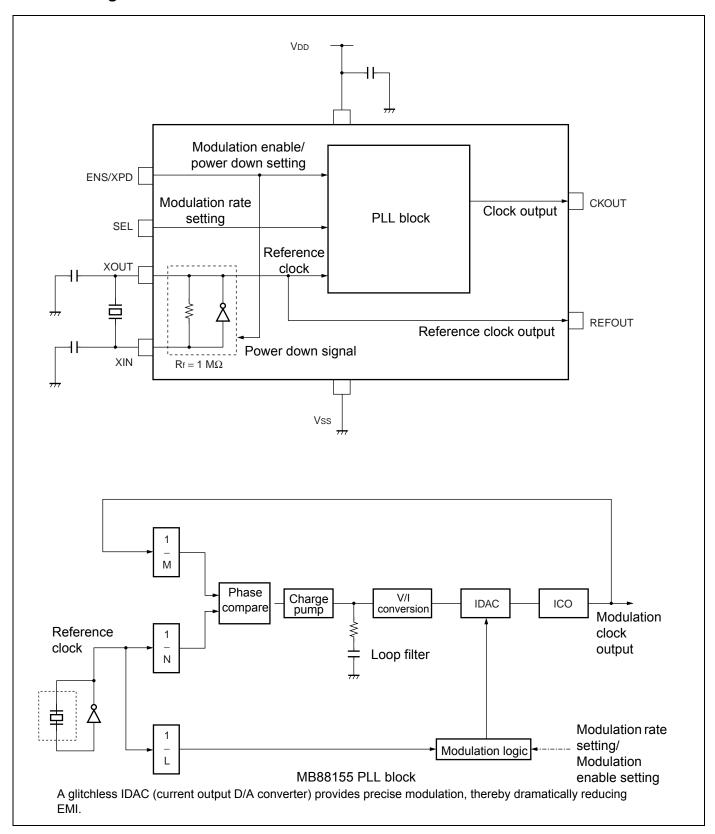
Noise near the XIN and XOUT pins may cause the device to malfunction. Design printed circuit boards so that electric wiring of XIN or XOUT pin and the resonator do not intersect other wiring.

Design the printed circuit board that surrounds the XIN and XOUT pins with ground.

Document Number: 002-08298 Rev. \*B Page 7 of 27



## 6. Block Diagram





## 7. Pin Setting

The modulation clock requires stabilization wait time after the PIN setting is changed. For the modulation clock stabilization wait time, assure the maximum value for "Lock-up time" in the AC Characteristics list in "Electrical Characteristics".

**ENS Modulation Enable Setting** 

| ENS | Modulation                     |                      |  |  |  |
|-----|--------------------------------|----------------------|--|--|--|
| L   | No modulation MB88155-xx0, xx1 |                      |  |  |  |
| Н   | Modulation                     | 1VID00 133-XXU, XX 1 |  |  |  |

Note: Spectrum does not diffuse when "L" is set to ENS pin.

MB88155-xx2, xx3 do not have ENS pin.

#### **XPD Power Down**

| XPD | Status            |                   |  |  |  |
|-----|-------------------|-------------------|--|--|--|
| L   | Power down status | MB88155-xx2, xx3  |  |  |  |
| Н   | Operating status  | 10100133-332, 333 |  |  |  |

Note: When setting "L" to XPD pin, it becomes power down mode (low power consumption mode).

Both CKOUT and REFOUT of output pins are fixed to "L" output during power down.

MB88155-xx0, xx1 do not have XPD pin.

#### **SEL Modulation Rate Setting**

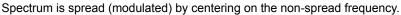
| SEL | Frequency |             |  |  |  |
|-----|-----------|-------------|--|--|--|
| L   | ± 0.5%    | MB88155-x1x |  |  |  |
|     | - 1.0%    | MB88155-x0x |  |  |  |
| Н   | ± 1.0%    | MB88155-x1x |  |  |  |
|     | - 2.0%    | MB88155-x0x |  |  |  |

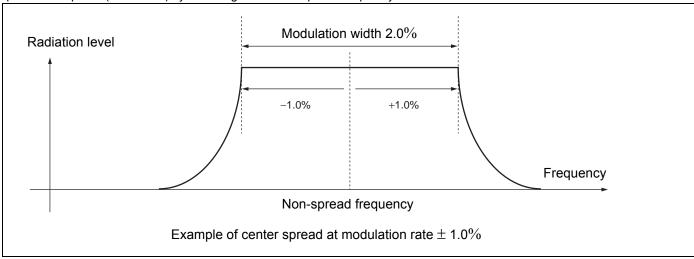
Note: The modulation rate can be changed at the level of the pin.

Document Number: 002-08298 Rev. \*B Page 9 of 27



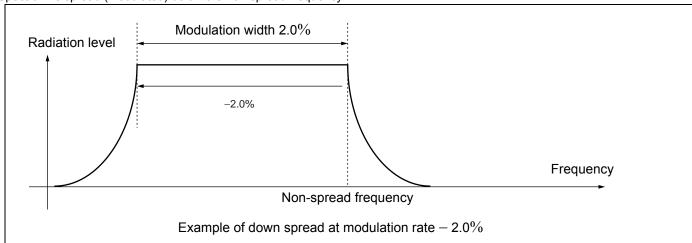
### ■ Center Spread





#### ■ Down Spread

Spectrum is spread (modulated) below the non-spread frequency.



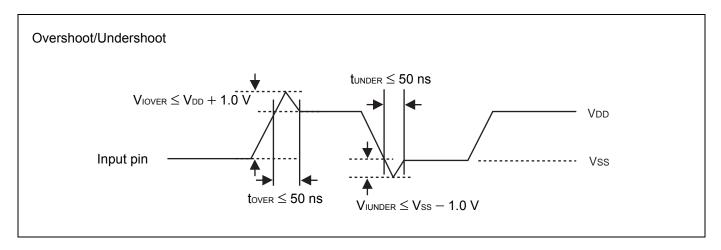


## 8. Absolute Maximum Ratings

| Parameter                      | Symbol          | Rating   |  |        |  |  |
|--------------------------------|-----------------|--|--|--------|--|--|
| Farameter                      | Symbol          | Min  | Max  | - Unit |  |  |
| Power supply voltage*          | V <sub>DD</sub> | - 0.5  | + 4.0  | V      |  |  |
| Input voltage*                 | Vı              | Vss - 0.5  | V <sub>DD</sub> + 0.5                            | V      |  |  |
| Output voltage*                | Vo              | Vss - 0.5  | V <sub>DD</sub> + 0.5                            | V      |  |  |
| Storage temperature            | Тѕт             | <b>– 55</b>  | + 125  | °C     |  |  |
| Operation junction temperature | TJ              | - 40   | - 40 + 125                                       |        |  |  |
| Output current                 | lo              | <del>- 14</del>                                    | + 14   | mA     |  |  |
| Overshoot                      | Viover          | _  | $V_{DD} + 1.0 \text{ (tover} \le 50 \text{ ns)}$ | V      |  |  |
| Undershoot                     | Viunder         | $V_{SS} - 1.0 \text{ (tunder} \leq 50 \text{ ns)}$ | _  | V      |  |  |

 $<sup>^{\</sup>star}$ : The parameter is based on Vss = 0.0 V.

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.



Document Number: 002-08298 Rev. \*B



### 9. Recommended Operating Conditions

(Vss = 0.0 V)

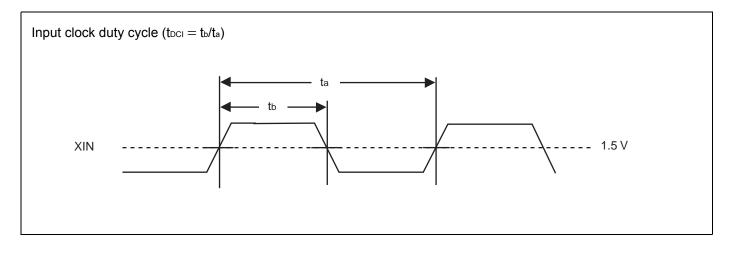
| Parameter               | Symbol          | Din                   | Pin Conditions     | Value                 |     |                       | Unit  |
|-------------------------|-----------------|-----------------------|--------------------|-----------------------|-----|-----------------------|-------|
|                         | Symbol          | FIII                  | Conditions         | Min                   | Тур | Max                   | Oille |
| Power supply voltage    | V <sub>DD</sub> | V <sub>DD</sub>       | _                  | 3.0                   | 3.3 | 3.6                   | V     |
| "H" level input voltage | ViH             | XIN, SEL,<br>ENS, XPD | _                  | V <sub>DD</sub> × 0.8 | _   | V <sub>DD</sub> + 0.3 | V     |
| "L" level input voltage | VIL             | XIN, SEL,<br>ENS, XPD | _                  | Vss                   | _   | V <sub>DD</sub> × 0.2 | V     |
| Input clock duty cycle  | <b>t</b> DCI    | XIN                   | 12.5 MHz to 50 MHz | 40                    | 50  | 60                    | %     |
| Operating temperature   | Та              | _                     | _                  | <b>- 40</b>           | _   | + 85                  | °C    |

WARNING:

The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their Cypress representatives beforehand.





## 10. Electrical Characteristics

### ■ DC Characteristics

(Ta = -40 °C to +85 °C, V<sub>DD</sub> = 3.3 V  $\pm$  0.3 V, V<sub>SS</sub> = 0.0 V)

| Parameter              | Compleal | Di-                  | Conditions   |                       | Value |                 | l lmit |
|------------------------|----------|----------------------|--|-----------------------|-------|-----------------|--------|
|                        | Symbol   | Pin                  | Conditions   | Min                   | Тур   | Max             | Unit   |
| Power supply current   | Icc      | $V_{DD}$             | 24 MHz output<br>No load capacitance                             | _                     | 5.0   | 7.0             | mA     |
|                        |          |                      | At power-down  | _                     | 10    | _               | μА     |
|                        | Vонс     | CKOUT                | "H" level output<br>Іон = -4 mA                                  | V <sub>DD</sub> - 0.5 | _     | V <sub>DD</sub> | V      |
| Output voltage         | Vohr     | REFOUT               | "H" level output<br>Іон = - 3 mA                                 |                       |       |                 |        |
|                        | Volc     | CKOUT                | "L" level output IoL = 4 mA                                      | Vss                   | _     | 0.4             | V      |
|                        | Volr     | REFOUT               | "L" level output IoL = 3 mA                                      |                       |       |                 |        |
| Output impedance       | Zoc      | CKOUT                | 12.5 MHz to 80 MHz   | _                     | 45    | _               | Ω      |
| Output impedance       | Zor      | REFOUT               | 12.5 MHz to 50 MHz   | _                     | 70    | _               |        |
| Input capacitance      | Cin      | XIN, SEL,<br>ENS/XPD | $Ta = +25  ^{\circ}C$<br>$V_{DD} = V_{I} = 0.0  V$<br>f = 1  MHz | _                     | _     | 16              | pF     |
| Input pull-up resistor | Rpu      | ENS                  | VIL = 0.0 V  | 25                    | 50    | 200             | kΩ     |
|                        |          | REFOUT               | 12.5 MHz to 50 MHz   | _                     | _     | 15              | pF     |
| Load capacitance       | C∟       | CKOUT                | 12.5 MHz to 50 MHz   | _                     | _     | 15              |        |
|                        |          |                      | 50 MHz to 80 MHz   | _                     |       | 7               |        |

Document Number: 002-08298 Rev. \*B Page 13 of 27



#### ■ AC Characteristics

(Ta = -40 °C to +85 °C, V<sub>DD</sub> = 3.3 V  $\pm$  0.3 V, Vss = 0.0 V)

| Dovemeter            | Cumbal           | Pin    | 0  |                         | I Incit |                         |      |
|----------------------|------------------|--------|--|-------------------------|---------|-------------------------|------|
| Parameter            | Symbol           |        | Conditions   | Min                     | Тур     | Max                     | Unit |
| Oscillation          |                  |        | XIN, Fundamental oscillation   |                         |         | 40                      | MHz  |
| requency             |                  | XOUT   | 3 <sup>rd</sup> overtone   | 40                      |         | 48                      |      |
| Input frequency      |                  | XIN    | MB88155 – 1x0, 1x2   | 12.5                    |         | 25                      | MHz  |
|                      | fin              |        | MB88155 – 1x1, 1x3   | 25                      | _       | 50                      |      |
|                      |                  |        | MB88155 – 400  | 12.5                    |         | 20                      |      |
|                      |                  | REFOUT | MB88155 – 1x0, 1x2   | 12.5                    |         | 25                      | MHz  |
| Output frequency     |                  |        | MB88155 – 1x1, 1x3   | 25                      | _       | 50                      |      |
|                      | r.               |        | MB88155 – 400  | 12.5                    | _       | 20                      |      |
|                      | fоит             | СКОИТ  | MB88155 – 1x0, 1x2   | 12.5                    | _       | 25                      |      |
|                      |                  |        | MB88155 – 1x1, 1x3   | 25                      | _       | 50                      |      |
|                      |                  |        | MB88155 – 400  | 50                      | _       | 80                      |      |
| Output slew rate     | SRc              | CKOUT  | Load capacitance 15 pF, 0.4 V to 2.4 V   | 0.4                     |         | 4.0                     | V/ns |
|                      | SRR              | REFOUT | Load capacitance 15 pF, 0.4 V to 2.4 V   | 0.3                     |         | 2.0                     |      |
| Output clock         | tocc             | CKOUT  | 1.5 V reference level  | 40                      | _       | 60                      | %    |
| duty cycle           | tocr             | REFOUT | 1.5 V reference level  | t <sub>DCI</sub> - 10*1 |         | t <sub>DCI</sub> + 10*1 |      |
| Modulation frequency | f <sub>MOD</sub> | CKOUT  | Input frequency at 24 MHz  | _                       | 32.4    | _                       | kHz  |
| Lock-up time*2       | <b>t</b> LK      | CKOUT  | _  | _                       | 2       | 5                       | ms   |
| Cycle-cycle jitter   |                  |        | MB88155 – 1xx<br>Input frequency<br>12.5 MHz to 20 MHz,<br>No load capacitance,<br>Ta = $+25$ °C, $V_{DD} = 3.3$ V,<br>Standard deviation $\sigma$ | _                       | _       | 150                     | ps   |
|                      | tuc C            | СКОПТ  | MB88155 – 1xx<br>Input frequency<br>20 MHz to 50 MHz,<br>No load capacitance,<br>Ta = $+25$ °C, $V_{DD} = 3.3$ V,<br>Standard deviation $\sigma$   | _                       | _       | 100                     | ps   |
|                      |                  |        | MB88155 $-$ 400 No load capacitance, Ta = $+$ 25 °C, V <sub>DD</sub> = 3.3 V, Standard deviation $\sigma$  | _                       |         | 200                     | ps   |

<sup>\*1:</sup> Duty of the REFOUT output is guaranteed only for the following A and B because it depends on too of input clock duty.

Document Number: 002-08298 Rev. \*B Page 14 of 27

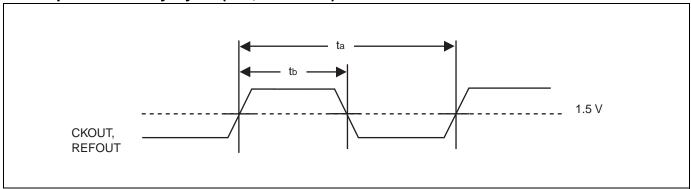
A. Resonator input: When resonator is connected with XIN pin and XOUT pin, and oscillates normally.

B. External clock input: The input level is Full-swing (Vss - VDD).

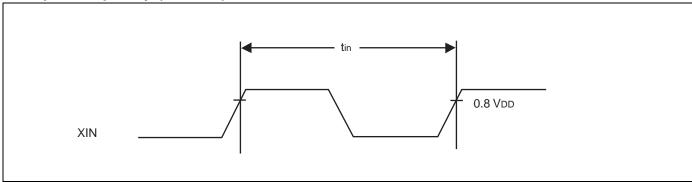
<sup>\*2:</sup> The modulation clock requires stabilization wait time after the IC is turned on or released from power-down mode, or after SEL (modulation factor) or ENS (modulation enable) setting is changed. For the modulation clock stabilization wait time, assure the maximum value for the lock-up time.



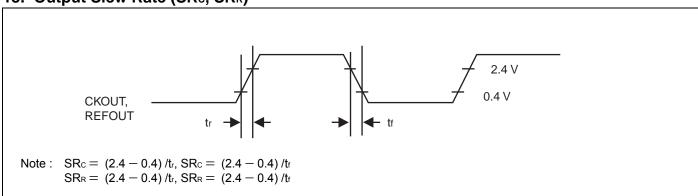
## 11. Output Clock Duty Cycle (tDCC, tDCR = tb/ta)



## 12. Input Frequency (fin = 1/tin)

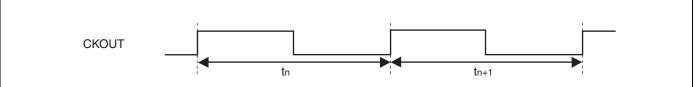


## 13. Output Slew Rate (SRc, SRR)





## 14. Cycle-Cycle Jitter ( $t_{JC} = |t_n - t_n + 1|$ )

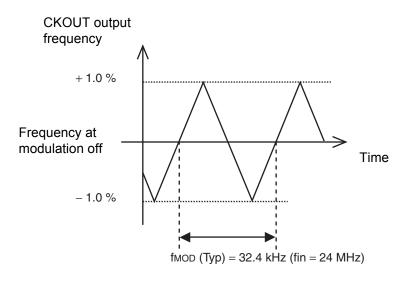


Note: Cycle-cycle jitter indicates the difference between a certain cycle and the immediately succeeding (or preceding) cycle.

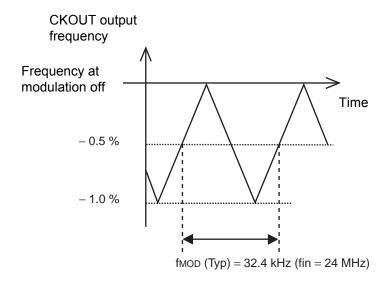


## 15. Modulation Waveform

■ Modulation rate  $\pm$  1.0%, example of center spread

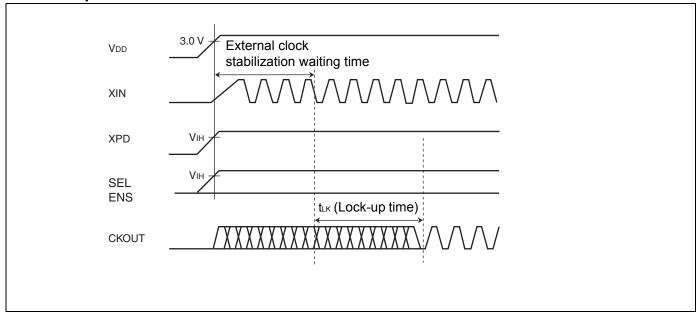


■ Modulation rate - 1.0%, example of down spread

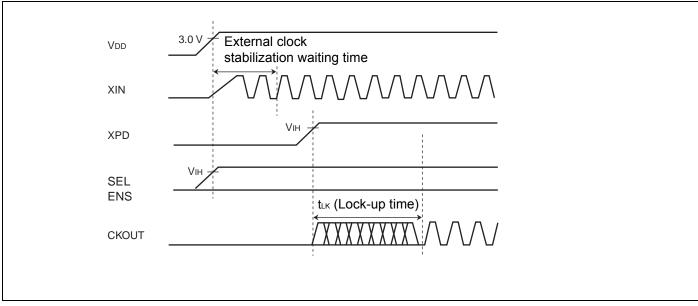




### 16. Lock-Up Time



If the XPD pin is fixed at the "H" level, the maximum time after the power is turned on until the set clock signal is output from CKOUT pin is (the stabilization wait time of input clock to XIN pin) + (the lock-up time "tlk"). For the input clock stabilization time, check the characteristics of the resonator or oscillator used.

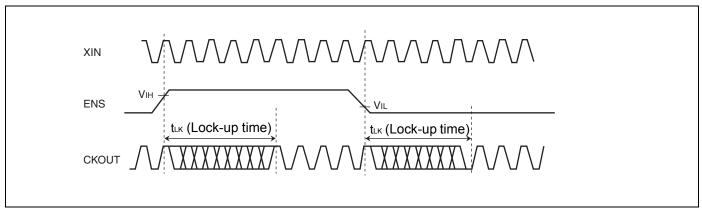


If the XPD pin is used for power-down control, the set clock signal is output from the CKOUT pin at most the lock-up time "tlk" after the XPD pin goes "H" level.

(Continued)



#### (Continued)



If the ENS pin is used for modulation enable control during normal operation, the set clock signal is output from the CKOUT pin at most the lock-up time "t\_k" after the level at the ENS pin is determined.

Note: The wait time for the clock signal output from the CKOUT pin to become stable is required after the IC is released from power-down mode by the XPD pin or after another pin's setting is changed. During the period until the output clock signal becomes stable, neither of the output frequency, output clock duty cycle, modulation period, and cycle-cycle jitter characteristic cannot be guaranteed. It is therefore advisable to take action, such as cancelling a device reset at the stage after the lock-up time has passed.

Document Number: 002-08298 Rev. \*B



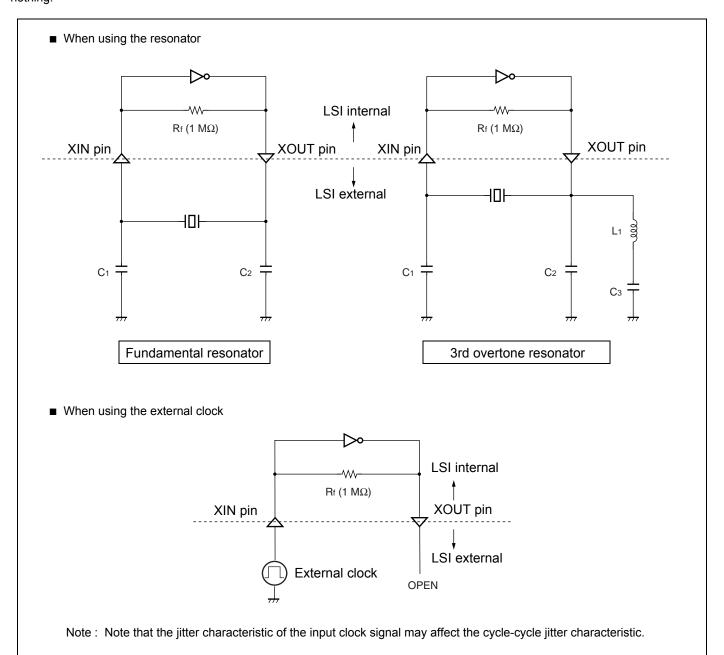
#### 17. Oscillation Circuit

The following schematic on the left-hand side shows a sample connection of a general resonator. The oscillation circuit contains a feedback resistor (1  $M\Omega$ ). The values of capacitors (C<sub>1</sub> and C<sub>2</sub>) must be adjusted to the optimum constant of the resonator used.

The following schematic on the right-hand side shows a sample connection of a 3rd overtone resonator. The values of capacitors ( $C_1$ ,  $C_2$ , and  $C_3$ ) and inductor ( $L_1$ ) must be adjusted to the optimum constant of the resonator used.

The most suitable value is different by individual resonator. Please refer to the resonator manufacturer which you use for the most suitable value.

To use an external clock signal (without using the resonator), input the clock signal to the XIN pin with the XOUT pin connected to nothing.

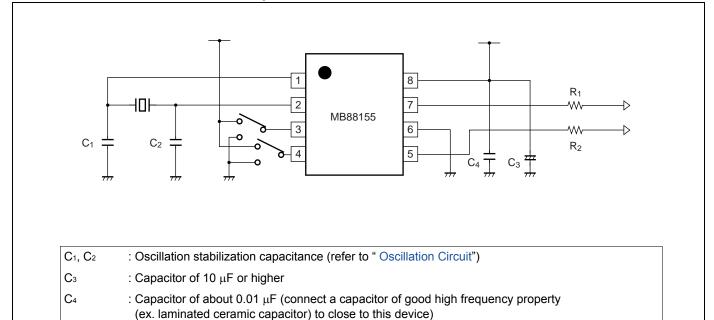


Document Number: 002-08298 Rev. \*B Page 20 of 27



R<sub>1</sub>, R<sub>2</sub>

## 18. Interconnection Circuit Example



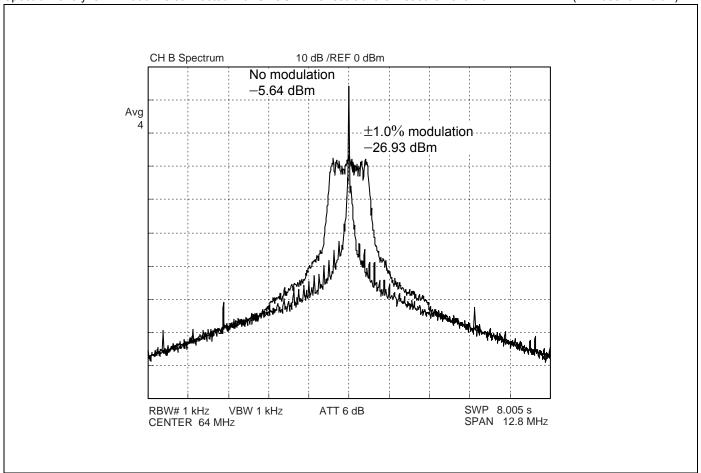
: Impedance matching resistor for board pattern



### 19. Spectrum Example Characteristics

The condition of the examples of the characteristic is shown as follows: Input frequency = 16 MHz (Output frequency = 64 MHz: Using MB88155 (Multiplied by 4))

Power-supply voltage = 3.3 V, None load capacity. Modulation rate =  $\pm 1.0\%$  (center spread). Spectrum analyzer HP4396B is connected with CKOUT. The result of the measurement with RBW = 1 kHz (ATT use for -6 dB) .



Page 23 of 27



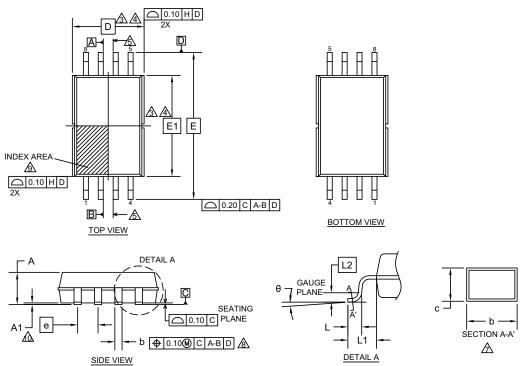
## 20. Ordering Information

| Part Number                  | Input<br>Frequency    | Multiplica-<br>tion Rate | Output<br>Frequency                 | Modulation<br>Type        | Modulation<br>Enable<br>Pin | Power<br>Down<br>Pin | Package                              | Remarks                       |                     |
|------------------------------|-----------------------|--------------------------|-------------------------------------|---------------------------|-----------------------------|----------------------|--------------------------------------|-------------------------------|---------------------|
| MB88155PFT-G-<br>100-JN-EFE1 | 12.5 MHz to<br>25 MHz | Multiplied<br>by 1       | The same<br>as input fre-<br>quency |                           | Yes                         | No                   | - 8-pin plastic<br>TSSOP<br>(STA008) | Emboss<br>taping<br>(EF type) |                     |
| MB88155PFT-G-<br>102-JN-EFE1 | 12.5 MHz to<br>25 MHz |                          |                                     | as input fre- Down spread | No Yes                      | Vac                  |                                      |                               |                     |
| MB88155PFT-G-<br>103-JN-EFE1 | 25 MHz to 50<br>MHz   |                          |                                     |                           |                             | 165                  |                                      |                               |                     |
| MB88155PFT-G-<br>110-JN-EFE1 | 12.5 MHz to<br>25 MHz |                          | The same<br>as input fre-<br>quency |                           | Yes                         | No                   |                                      |                               |                     |
| MB88155PFT-G-<br>111-JN-EFE1 | 25 MHz to 50<br>MHz   |                          |                                     | as input fre-             | Center<br>spread            | res                  | NO                                   | (31A000)                      | (Er type)           |
| MB88155PFT-G-<br>112-JN-EFE1 | 12.5 MHz to<br>25 MHz |                          |                                     |                           | No                          | Yes                  |                                      |                               |                     |
| MB88155PFT-G-<br>400-JN-EFE1 | 12.5 MHz to<br>20 MHz | Multiplied<br>by 4       | 50 MHz to<br>80 MHz                 | Down<br>spread            | Yes                         | No                   |                                      |                               |                     |
| MB88155PFT-G-<br>100-JN-ERE1 | 12.5 MHz to<br>25 MHz |                          | The same as input frequency         | Down                      | Yes                         | No                   |                                      |                               |                     |
| MB88155PFT-G-<br>103-JN-ERE1 | 25 MHz to<br>50 MHz   |                          |                                     | as input fre-             | spread                      | No                   | Yes                                  |                               |                     |
| MB88155PFT-G-<br>110-JN-ERE1 | 12.5 MHz to<br>25 MHz | Multiplied<br>by 1       |                                     |                           |                             | Yes                  | No                                   | 8-pin plastic<br>TSSOP        | Emboss              |
| MB88155PFT-G-<br>111-JN-ERE1 | 25 MHz to<br>50 MHz   | quency                   |                                     |                           | Center<br>spread            | res                  | NO                                   | (STA008)                      | taping<br>(ER type) |
| MB88155PFT-G-<br>112-JN-ERE1 | 12.5 MHz to<br>25 MHz |                          |                                     |                           | No                          | Yes                  |                                      |                               |                     |
| MB88155PFT-G-<br>400-JN-ERE1 | 12.5 MHz to<br>20 MHz | Multiplied<br>by 4       | 50 MHz to<br>80 MHz                 | Down<br>spread            | Yes                         | No                   |                                      |                               |                     |

Document Number: 002-08298 Rev. \*B



### 21. Package Dimensions



| SYMBOL   | DIMENSION |          |       |  |  |
|----------|-----------|----------|-------|--|--|
| STIVIBOL | MIN. NOM. |          | MAX.  |  |  |
| Α        |           |          | 1.20  |  |  |
| A1       | 0.05      |          | 0.15  |  |  |
| D        | 3.10 BSC  |          |       |  |  |
| E        | 6.40 BSC  |          |       |  |  |
| E1       | 4.40 BSC  |          |       |  |  |
| θ        | 0°        | _        | 8°    |  |  |
| С        | 0.047     | —        | 0.207 |  |  |
| b        | 0.12      | 0.22     | 0.32  |  |  |
| L        | 0.50      | 0.60     | 0.70  |  |  |
| L 1      | 1.00 REF  |          |       |  |  |
| L 2      | (         | 0.25 BSC |       |  |  |
| е        | 0.65 BSC  |          |       |  |  |

#### **NOTES**

- 1. ALL DIMENSIONS ARE IN MILLIMETER.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- ⚠ DIMENSIONING D INCLUDE MOLD FLASH, DIMENSIONING E1 DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.025 mm PER SIDE. D and E1 DIMENSION ARE DETERMINED AT DATUM H.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM.

  DIMENSIONING D and E1 ARE DETERMINED AT THE OUTERMOST

  EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH,

  THE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING

  ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- ⚠ DATUMS A & B TO BE DETERMINED AT DATUM H.
- 6. "N" IS THE MAXIMUM NUMBER OF TERMINAL POSITIONS FOR THE SPECIFIED PACKAGE LENGTH.
- ⚠ THE DIMENSION APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 mm TO 0.25mm FROM THE LEAD TIP.
- ⚠ DIMENSION "b" DOES NOT INCLUDE THE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.10mm TOTAL IN EXCESS OF THE "b" DIMENSION AT MAXIMUM MATERIAL CONDITION.
  - THE DAMBAR MAY NOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.
- ⚠ THIS CHAMFER FEATURE IS OPTIONAL. LF IT IS NOT PRESENT, THEN A PIN 1 IDENTIFIER MUST BE LOCATED WITHIN THE INDEX AREA INDICATED
- /1Ò "A1" IS DEFINED AS THE VERTICAL DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY EXCLUDING THE LID AND OR THERMAL ENHANCEMENT ON CAVITY DOWN PACKAGE CONFIGURATIONS.
- 11. JEDEC SPECIFICATION NO. REF: N/A

002-15912 Rev. \*\*



## **Document History**

**Spansion Publication Number: DS04-29119-2Ea** 

|          | Document Title: MB88155 Spread Spectrum Clock Generator<br>Document Number: 002-08298 |                    |                    |  |  |  |
|----------|---|--------------------|--------------------|--|--|--|
| Revision | ECN   | Orig. of<br>Change | Submission<br>Date | Description of Change  |  |  |
| **       | _   | TAOA               | 11/09/2006         | Initial Release  |  |  |
| *A       | 5568597   | TAOA               | 12/29/2016         | Updated to Cypress Template  |  |  |
| *B       | 5998865   | TAOA               | 01/04/2018         | Deleated EOL part number: MB88155-101/113/402/410/412 Updated Package Dimensions: Updated to Cypress format Changed the package name from FPT-8P-M07 to STA008 |  |  |

Document Number: 002-08298 Rev. \*B Page 26 of 27



### Sales, Solutions, and Legal Information

#### Worldwide Sales and Design Support

Cypress maintains a worldwide network of offices, solution centers, manufacturer's representatives, and distributors. To find the office closest to you, visit us at Cypress Locations.

cypress.com/usb

cypress.com/wireless

#### **Products**

USB Controllers
Wireless Connectivity

Arm® Cortex® Microcontrollers cypress.com/arm Automotive cypress.com/automotive Clocks & Buffers cypress.com/clocks Interface cypress.com/interface Internet of Things cypress.com/iot Memory cypress.com/memory Microcontrollers cypress.com/mcu **PSoC** cypress.com/psoc Power Management ICs cypress.com/pmic Touch Sensing cypress.com/touch

### PSoC® Solutions

PSoC 1 | PSoC 3 | PSoC 4 | PSoC 5LP | PSoC 6 MCU

#### **Cypress Developer Community**

Community | Projects | Video | Blogs | Training | Components

#### **Technical Support**

cypress.com/support

© Cypress Semiconductor Corporation, 2005-2018. This document is the property of Cypress Semiconductor Corporation and its subsidiaries, including Spansion LLC ("Cypress"). This document, including any software or firmware included or referenced in this document ("Software"), is owned by Cypress under the intellectual property laws and treaties of the United States and other countries worldwide. Cypress reserves all rights under such laws and treaties and does not, except as specifically stated in this paragraph, grant any license under its patents, copyrights, trademarks, or other intellectual property rights. If the Software is not accompanied by a license agreement and you do not otherwise have a written agreement with Cypress governing the use of the Software, then Cypress hereby grants you a personal, non-exclusive, nontransferable license (without the right to sublicense) (1) under its copyright rights in the Software provided in source code form, to modify and reproduce the Software solely for use with Cypress hardware products, only internally within your organization, and (b) to distribute the Software in binary code form externally to end users (either directly or indirectly through resellers and distributors), solely for use on Cypress hardware product units, and (2) under those claims of Cypress's patents that are infringed by the Software (as provided by Cypress, unmodified) to make, use, distribute, and import the Software solely for use with Cypress hardware products. Any other use, reproduction, modification, translation, or compilation of the Software is prohibited.

TO THE EXTENT PERMITTED BY APPLICABLE LAW, CYPRESS MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARD TO THIS DOCUMENT OR ANY SOFTWARE OR ACCOMPANYING HARDWARE, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE. No computing device can be absolutely secure. Therefore, despite security measures implemented to Cypress hardware or software products. Cypress does not assume any liability arising out of any security breach, such as unauthorized access to or use of a Cypress product. In addition, the products described in these materials may contain design defects or errors known as errata which may cause the product to deviate from published specifications. To the extent permitted by applicable law, Cypress reserves the right to make changes to this document without further notice. Cypress does not assume any liability arising out of the application or use of any product or circuit described in this document. Any information provided in this document, including any sample design information or programming code, is provided only for reference purposes. It is the responsibility of the user of this document to properly design, program, and test the functionality and safety of any application made of this information and any resulting product. Cypress products are not designed, intended, or authorized for use as critical components in systems designed or intended for the operation of weapons, weapons systems, nuclear installations, life-support devices or systems, other medical devices or systems (including resuscitation equipment and surgical implants), pollution control or hazardous substances management, or other uses where the failure of the device or system could cause personal injury, death, or property damage ("Unintended Uses"). A critical component is any component of a device or system whose failure to perform can be reasonably expected to cause the failure of the device or system, or to affect its safety or effectiveness. Cypress is not l

Cypress, the Cypress logo, Spansion, the Spansion logo, and combinations thereof, WICED, PSoC, CapSense, EZ-USB, F-RAM, and Traveo are trademarks or registered trademarks of Cypress in the United States and other countries. For a more complete list of Cypress trademarks, visit cypress.com. Other names and brands may be claimed as property of their respective owners.